Controlling the morphology of copper-silica nanocomposites from laser ablation in liquid

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Controlling the morphology of copper-silica nanocomposites from laser ablation in liquid

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Abstract

Synthesis of copper-silica nanocomposites with controllable morphology and composition were produced with a one-step femtosecond reactive laser ablation in liquid (fs-RLAL) technique. The composite nanomaterials were generated by focusing femtosecond near-IR laser pulses onto a silicon wafer immersed in an aqueous copper(II) nitrate solution, with the solution pH adjusted using nitric acid or potassium hydroxide. Under acidic conditions (pH 3.0 and 5.4), little copper was incorporated in the predominantly silica product (1.4 and 1.5 wt.%). These acidic conditions yielded large ~30–80 nm silica particles, with some particles consisting of copper core/silica shell. In contrast, increasing the solution pH to 10.4 resulted in extremely high Cu loading of 31.5 wt.% and a composite product consisting of 1.5 nm copper clusters distributed throughout a matrix of amorphous silica and copper phyllosilicate. The relationship between the precursor solution pH and the product morphology and copper loading is attributed to the point of zero charge (PZC) of silica, in which the high solution pH allows for electrostatic adsorption to occur between the deprotonated silica clusters from the ablated silicon wafer and the copper hydroxide dimer formed in solution.

Keywords: reactive laser ablation in liquid, femtosecond laser, copper-silica nanocomposite, copper phyllosilicate
1. Introduction

Copper nanoparticles (Cu NPs) are valued for their low cost, high conductivity, and thermal stability, making them a popular alternative to rare earth metals for biological sensing and imaging [1], antimicrobial applications [2], inkjet-printable electronics [3], and catalysis [4]. In particular, the ability of copper to access many oxidation states makes supported Cu NPs active catalysts towards reactions such as electrochemical reduction [5], thermochemical hydrogenation [6] and photochemical reduction [7] of CO$_2$, photocatalytic degradation of organic dyes [8], and other organic transformations [9–11].

While Cu NPs possess high catalytic activity and high temperature stability, a major bottleneck to using copper-based nanomaterials for catalysis is the propensity for small Cu NPs to agglomerate, and for Cu surfaces to oxidize. Support materials such as graphene, oxides, polymers, and metal-organic frameworks (MOFs) are added to prevent agglomeration and surface oxidation, while preserving the high catalytic activity of Cu NPs [4, 12, 13]. In particular, silica has been used as a support material for various metal NPs due to the silanol surface groups that enhance binding with metal NPs [4, 14]. The majority of synthetic approaches to fabricating copper-silica nanostructures involve wet chemical methods such as incipient wetness impregnation, deposition-precipitation, strong electrostatic adsorption, and ammonia evaporation [4, 5, 11, 13–15]. In these methods, the silica is either prepared by the Stöber method or purchased commercial amorphous/fumed silica, and the copper is added in the form of a salt complex. Copper-silica bonding is achieved by heating up the slurry or solution, followed by calcining the finished product. A drawback of many of these methods is that uneven distribution of the copper complex throughout the silica often results in poorly dispersed Cu NPs with large size distributions and low copper loading.

Laser ablation in liquid (LAL) has recently emerged as a robust alternative synthesis route to myriad (supported) NPs that can overcome many challenges inherent in wet-chemical synthesis [16–19]. LAL involves focusing intense laser
pulses onto a solid target immersed in liquid, which produces a localized plasma at the solid-liquid interface containing reactive electrons, radicals, and ions [20]. The plasma reaches transient temperatures exceeding 5000 K that cool on sub-microsecond timescales due to the surrounding ambient liquid [21]. These highly nonequilibrium conditions generate NPs comprised of the target material with exotic metastable phases and bonding environments that are stable without added capping agents, making them ideal for catalysis applications [16–18]. Because LAL generates nanomaterials under ambient conditions in water, it is considered a ‘green’ and sustainable synthesis method [16, 22]. LAL of a Cu target in various solvents have been widely used to synthesize Cu NPs with solvent- and laser-dependent oxidation states and morphologies [23–26].

When LAL is carried out in a solution containing metal ions or other species that interact with the ablated target atoms, the technique is referred to as Reactive Laser Ablation in Liquid (RLAL) [16]. The first demonstration of RLAL in 2008 produced Ag and Au NPs by ablating a silicon wafer immersed in either Ag(NO$_3$)$_2$ or HAuCl$_4$ aqueous solutions [27]. Since this initial work, many metastable and unique bi- and multi-metallic nanostructures have been reported. For instance, mixed-metal Pt-Co and Pt-Co-Cu oxide NPs for fuel cell applications were synthesized by ablating a Co target immersed in Pt and Cu metal salt solutions [28–30], and Ni-Fe layered hydroxides doped with Ti and La for electrochemical water splitting were synthesized by ablation of Fe powder in aqueous solutions of Ni, Ti, and La salts [31, 32]. Complex metal-oxide mineral phases of copper and zinc were synthesized by RLAL of Zn or Cu targets immersed in aqueous Zn or Cu salt solutions [33], and silica-supported Au or Ag nanomaterials have been synthesized by ablating silicon wafers in aqueous gold or silver salt solutions [27, 34–36]. Recently, we generated sub-3 nm Au NPs dispersed throughout a silica matrix by ablating a silicon wafer immersed in a [AuCl$_4$]$^-$ solution using femtosecond laser pulses [36].

In this work we report the synthesis and characterization of copper-silica nanocomposites generated from a femtosecond-RLAL (fs-RLAL) technique, in which fs laser pulses are focused onto a silicon wafer immersed in Cu(NO$_3$)$_2$
solutions under three pH conditions. The product morphology and Cu loading on the silica were strongly dependent on the precursor solution pH, with the highest copper loading achieved at pH 10.4. This pH-dependent copper loading was reflected in the catalytic activity of the samples, determined using the model reaction of catalytic para-nitrophenol reduction by sodium borohydride [37]. We will discuss the role that the solution pH plays on the surface charge of ablated silica species, and how surface interactions drive the formation of different morphology and wt.% loading of Cu in the products.

2. Materials and Methods

2.1. Materials

Silicon wafers (n-doped, (111)-oriented, single side polished, 300 μm thick, NOVA electronic materials), copper(II) nitrate, Cu(NO$_3$)$_2$ (Fisher), potassium hydroxide, KOH (Fisher), nitric acid, HNO$_3$ (Fisher), sodium borohydride, NaBH$_4$ (Acros Organics), and para-nitrophenol, PNP (Acros Organics) were used as received. Stock and working solutions were prepared with purified water from a Millipore Ultrapure water system (resistivity is 18.2 MΩcm$^{-1}$ at 25°C).

2.2. Sample Preparation

Working solutions of Cu(NO$_3$)$_2$ (2.0 mM) were prepared from a freshly prepared aqueous stock solution (50 mM) and the pH was recorded as ~5.4. Either HNO$_3$ (1.0 mM) was added from a 10 mM stock solution or KOH (5.0 mM) was added from a 200 mM stock, resulting in working solution pH values of 3.0 and 10.4, respectively. The working solution was transferred to a quartz cuvette (3 mL) equipped with a stir bar, and a pre-cut silicon wafer was placed in the cuvette and secured to one side.

fs-RLAL irradiation of the Si wafer immersed in the working solution was conducted for 30 min while stirring (details of laser parameters in section 2.4), followed by centrifugation for 15 min at 6,000 rpm (Thermo Fisher AccuSpin)
Micro 17). The supernatant was replaced with water and centrifuged a second time for 15 min at 6,000 rpm. The resulting pellet was collected for either characterization or redispersed in water and tested for its catalytic activity. The following naming convention was used for all samples: Cu-silica-[solution pH]. For example, Cu-silica-3.0 corresponds to the sample containing 2.0 mM Cu(NO$_3$)$_2$ and 1.0 mM HNO$_3$, with a pH of 3.0. Table 1 displays the sample names and solution compositions for clarity.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Solution Composition$^a$</th>
<th>Initial Solution pH</th>
</tr>
</thead>
<tbody>
<tr>
<td>Cu-silica-3.0</td>
<td>2 mM Cu(NO$_3$)$_2$ + 1 mM HNO$_3$</td>
<td>3.0±0.1</td>
</tr>
<tr>
<td>Cu-silica-5.4</td>
<td>2 mM Cu(NO$_3$)$_2$</td>
<td>5.4±0.1</td>
</tr>
<tr>
<td>Cu-silica-10.4</td>
<td>2 mM Cu(NO$_3$)$_2$ + 5 mM KOH</td>
<td>10.4±0.2</td>
</tr>
</tbody>
</table>

Table 1: Sample, solution composition, and initial solution pH values for experiments. $^a$all solution prepared in DI water.

2.3. Catalytic Reduction of Para-nitrophenol

The catalytic reduction of para-nitrophenol (PNP) by NaBH$_4$ was carried out in a home-built in situ UV-vis spectrometer (details in section 2.4). In a typical catalytic run, the collected pellet (details in section 2.2) was dispersed in water (3.0 mL) and 300 µL of this solution was added to a cuvette containing PNP (0.1 mM) and NaBH$_4$ (10 mM) while stirring. The PNP was added from a stock solution (1.5 mM) and the NaBH$_4$ was added from a freshly prepared stock solution (100 mM). The absorbance at 400 nm (as the para-nitrophenolate ion) was recorded, and the reaction was considered complete when it had disappeared completely. Data processing for the PNP reaction was conducted based on the methods of Ref. [38] and details are provided in the Supplemental Information (Fig. S1).

2.4. Instrumentation

The experimental laser setup has been described in detail in Refs. [36, 39, 40]. Briefly, a Ti:Sapphire regenerative amplifier delivering 7 mJ, 30 fs
pulses with a bandwidth centered at 800 nm and a repetition rate of 1 kHz was attenuated to 200 µJ for the ablation experiments. The 10×10×40 mm quartz fluorescence cuvette containing the pre-cut silicon wafer was placed 10 mm before the focal point of a \( f = 50 \) mm lens. The converging beam propagates through 9.7 mm of liquid to reach the 0.3 mm thick Si wafer. We note that no white light was generated on the front face of the cuvette because the large initial beam diameter of 11 mm and high numerical aperture of the focusing lens were sufficient to eliminate any nonlinear optical effects until a few mm before the Si-liquid interface. The spot size on the wafer was 85 µm diameter, measured using an optical microscope of an ablated Si wafer. Under these conditions, the laser fluence was 3.5 J cm\(^{-2}\) and peak intensity was 1.17×10\(^{14}\) W cm\(^{-2}\). The cuvette was placed on a micro-stir plate (Thermo Scientific) mounted on x- and y- motorized translation stages (Thorlabs), which moved in a zig-zag pattern at a velocity of 0.5 mm/s.

PNP catalysis runs were carried out in a home-built in situ UV-vis spectrometer, with a deuterium-tungsten light source (Ocean Optics, DH2000-DUV), optical fibers, a sample holder for 10×10×40 mm cuvettes placed on a stir plate (300 rpm stir rate), and a compact spectrometer (Ocean Optics HR4000). Spectra were collected every 1.2 seconds using LabVIEW software (National Instruments).

2.5. Characterization

Transmission Electron Microscopy (TEM) TEM images were collected on a JEOL JEM-1230 TEM at 120 kV. High resolution TEM (HRTEM) images and SAED patterns were collected on an FEI Titan 80–300 kV with a Gatan 794 Multi-Scan Camera. Samples were prepared by drop-casting the diluted pellet onto a carbon-coated copper grid (100 mesh, Ted Pella, Inc.) and left to dry for at least 24 hr at room temperature. Size distributions were determined by measuring 300 individual particles from three separate parts of the grid using ImageJ software. Gatan Microscopy Software Suite version 3.x was used to determine the crystal lattices of the nanoparticles in the HRTEM images.
Details on this process are included in the Supplemental Information (Fig. S2).

**Scanning Electron Microscopy-Energy Dispersive X-ray Spectroscopy (SEM-EDX)** SEM-EDX was carried out on a Hitachi FE SEM SU-70 (spatial resolution 1.0 nm) equipped with an Energy Dispersive X-ray Spectroscopy (EDX) detector. Images were obtained at 10 keV and elemental analysis was conducted at 15 keV, with ZAF standardless quantification employed for EDS measurements. Samples were prepared by drop casting the centrifuged pellets onto conductive carbon tape stabilized on an aluminum stage, and drying under vacuum at room temperature.

**X-ray Photoelectron Spectroscopy (XPS)** XPS was conducted on a PHI VersaProbe III Scanning XPS Microprobe with a monochromatic Al $k_{\alpha}$ X-ray source ($1486.6$ eV) run at $25$ W and $15$ KV, with a pass energy set to $112$ eV for survey scans and $69$ eV for high resolution spectra. A spot diameter of $200$ $\mu$m was irradiated using a take off angle of $90^\circ$, and a detector was situated at an angle of $45^\circ$. Charge neutralization was achieved by employing an ion gun and a flood gun during the analysis. Samples were prepared by drop casting the centrifuged pellet onto conductive carbon tape. Sample analysis was carried out using CasaXPS Software version 2.3.19PR1.0, employing Gaussian and Lorentzian convolution to fit the spectral lines, and all high resolution spectra were corrected by shifting the C1s peak at $284.8$ eV.

**X-ray Diffraction (XRD)** XRD was conducted on a Panalytical Empyrean Diffractometer with CuK$\alpha$ radiation ($\lambda = 0.15418$ nm) at $40$ kV and $45$ mA, with scanning angle ($2\theta$) of $10-90^\circ$ and a gonio focusing geometry. Samples were prepared for XRD analysis by drying the centrifuged pellet under vacuum at room temperature.

**Fourier Transform Infrared Spectroscopy (FTIR)** FTIR analysis was conducted on a Nicolet iS50 FTIR spectrometer equipped with a mid- and far-IR-capable diamond ATR. Spectra were obtained using $32$ scans in the range of $4000$ to $400$ cm$^{-1}$ with $5$ cm$^{-1}$ resolution. Samples were prepared for FTIR analysis by drying the centrifuged pellet under vacuum at room temperature.
3. Results

3.1. Characterization

The three Cu-silica products are visualized in the TEM images displayed in Fig. 1a-c with detailed insets, and additional TEM images are reported in the Supplemental Information (Fig. S3). While all three products contain large spherical particles around \( \sim 70-100 \) nm in diameter, these particles are most abundant in the Cu-silica-3.0 sample, and rarely seen in the Cu-silica-10.4 sample. Many of the spherical particles in the Cu-silica-3.0 and Cu-silica-5.4 samples are smooth throughout the entire particle, while some have a darker core and lighter shell, indicative of a Cu-core and silica-shell structure (insets in Fig. 1a and b). The Cu-silica-3.0 sample had very few core-shell particles. Size distribution analysis was possible on only 43 particles, and histograms of the core and outer diameter are displayed in Fig. S3 in the Supplemental Material. The Cu-silica-5.4 had substantially more core-shell particles than the Cu-silica-3.0 sample, with size distribution analysis displayed in Figure 1d. The inner core had a mean diameter of 22.4±14.4 nm with sizes ranging from 2–63 nm, and the outer shell mean was 32.1±14.8 nm with sizes ranging 12–84 nm in diameter. The Cu-silica-10.4 sample exhibits completely different morphology from the samples produced at lower pH (Fig. 1c). This product predominantly contains small, 1.52±0.75 nm Cu NPs dispersed throughout a matrix made up of long nano-needles and amorphous structures, along with a few large spherical particles decorated with small Cu NPs (inset). A histogram of the Cu NPs is displayed in Fig. 1e fit to a Gaussian distribution.

HRTEM images of the Cu-silica-5.4 and Cu-silica-10.4 products are displayed in Fig. 2a and c with SAED patterns (Fig. 2b and d). HRTEM analysis was not performed on the Cu-silica-3.0 sample due to the low number of core-shell particles. The inset in the Cu-silica-10.4 HRTEM image shows a small crystalline nanoparticle with lattice spacings measuring 2.13 Å corresponding to the (200) plane of Cu\(_2\)O [41]. The bottom inset of Fig. 2a shows the amorphous structure of the silica. The SAED pattern in Fig. 2b has two faint diffraction
Figure 1: TEM images of Cu-silica samples at pH 3.0 (a), pH 5.4 (b), and pH 10.4 with histograms of Cu-silica-5.4 (e) and Cu-silica-10.4 (e).
rings measuring 2.41 Å and 2.04 Å corresponding to the (111) plane of Cu$_2$O and the (111) plane of fcc-Cu [42]. The Cu-silica-5.4 sample in Fig. 2c had some small crystalline nanoparticles with lattice spacings measuring 2.07 Å, corresponding to the (111) plane of fcc-Cu. It was difficult to confirm that the core of the core-shell particles was crystalline copper due to the thick amorphous layer over top of it (bottom inset in Fig. 2c). The SAED pattern of the Cu-silica-5.4 sample in Fig. 2d shows three faint rings with diameters 3.11 Å, 2.01 Å, and 1.14 Å, corresponding to the (111) plane of fcc-Si, the (111) and (311) planes of fcc-Cu [41]. Our results are consistent with the Cu crystalline phases generated by laser ablation of copper, in which the major phases of copper generated included Cu$_2$O and fcc-Cu [23–25].

Figure 2: HRTEM images of Cu-silica-10.4 (a) and Cu-silica-5.4 (c) with SAED patterns (b) and (d), respectively.
SEM-EDX analysis was performed on the three Cu-silica samples, with a representative EDX spectrum of the Cu-silica-10.4 sample displayed in Fig. 3. The peaks located at 0.525 keV, 0.950 keV, and 1.74 keV correspond to the O Kα, Cu Lα, and Si Kα lines. The inset graph shows the wt.% Cu, Si, and O quantified in the samples, and Table 2 displays the numerical values of wt.% Cu, Si, and O from EDX, XPS, and ICP-OES analysis. The Cu-silica-10.4 sample contains the highest amount of Cu, about ten to twenty times the amount as the Cu-silica-5.4 and Cu-silica-3.0 samples. The significantly higher Cu loading in the Cu-silica-10.4 sample is corroborated by the ICP-OES and XPS results, also displayed in Table 2. XPS data was converted from atomic %, with calculations provided in Table S1 in the Supplemental Information. XPS analysis shows significant surface oxidation of the three samples, which is compensated for by the decrease in Cu content in the Cu-silica-10.4 sample, and decrease in Si content in the other two samples. The copper content did not decrease between EDX and XPS analysis for the Cu-silica-5.4 sample, suggesting that the copper present within the top 10 nm of this sample is protected from surface oxidation.

Figure 3: SEM-EDX spectrum of representative Cu-silica-10.4 sample with inset of wt.% of SiK, OK, and CuL for different pH solutions.
Table 2: weight % Cu from ICP-OES, weight % Cu, Si, and O from SEM-EDX, and XPS analysis. a analysis representative of entire sample material. b analysis representative of top 10 nm surface layer. c Values converted from atomic %, which is provided in Table S1 in the Supplemental Information.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Cu</th>
<th>Cu</th>
<th>Si</th>
<th>O</th>
<th>Cu</th>
<th>Si</th>
<th>O</th>
</tr>
</thead>
<tbody>
<tr>
<td>Cu-silica-3.0</td>
<td>1.4±0.4</td>
<td>4.3±0.9</td>
<td>67.5±1.5</td>
<td>28.1±0.7</td>
<td>0.3±0.3</td>
<td>40.1±0.1</td>
<td>59.6±31</td>
</tr>
<tr>
<td>Cu-silica-5.4</td>
<td>1.5±0.1</td>
<td>2.6±0.4</td>
<td>86.5±2.1</td>
<td>11.0±1.7</td>
<td>2.6±2.0</td>
<td>45.9±0.9</td>
<td>51.5±6.8</td>
</tr>
<tr>
<td>Cu-silica-10.4</td>
<td>31.5±0.4</td>
<td>36.5±2.1</td>
<td>37.3±4.6</td>
<td>26.2±2.6</td>
<td>19.2±6.1</td>
<td>22.6±2.7</td>
<td>58.1±5.5</td>
</tr>
</tbody>
</table>

High resolution Cu$_2$p$_{3/2}$ and Si$_2$p atomic orbital XP spectra are displayed in Fig. 4a and b with the Cu-silica-10.4 spectra on the bottom panels and the Cu-silica-5.4 and -3.0 samples on the top panels (a Si$_2$p spectrum of silica generated from ablating a silicon wafer in water is displayed in the Supplemental Information). No Cu was detected in the Cu$_2$p$_{3/2}$ spectrum for the Cu-silica-3.0 sample. In the Cu$_2$p$_{3/2}$ spectra, a peak at 932.7 eV (purple) was deconvoluted in both samples, which corresponds to either Cu$^0$ (932.6 eV) or Cu$^+$ as in Cu$_2$O (932.2 eV) [43–47]. The second peak around 934 eV in the Cu-silica-5.4 sample (blue) corresponds to Cu$^{2+}$ and matches that of a CuO species [42, 48, 49]. In the Cu-silica-10.4 sample, this feature it is shifted to 935.3 eV (black), corresponding to Cu$^{2+}$ interacting with silica [11, 42]. In particular, this feature matches the binding energy of copper phyllosilicate (Cu$_2$Si$_2$O$_5$(OH)$_2$, Cu-PS) near 935–936 eV [11, 49, 50]. The peaks around 942–945 eV correspond to shake up satellite features from the 2p$\rightarrow$3d transition from the 3d$^9$ ground state electron configuration of Cu$^{2+}$ [43, 44, 51]. This feature is strongly present in the Cu-silica-10.4 sample, and only weakly visible in the Cu-silica-5.4 sample due to its Cu low loading.

The Si$_2$p atomic orbitals in Fig. 4b have several silicon species, with a large peak centered around 103 eV corresponding to oxidized silica, and a small peak near 99 eV (green) corresponding to Si$^0$ [52, 53]. Within the large oxidized silicon peak around 103 eV, two species are deconvoluted for all three samples-
the peak at 103.5 eV (gray) corresponds to Si$^{4+}$ of Si–O–Si tetrahedrally co-
ordinated silicon in amorphous silica [53–55], and the feature at 102.2 eV (dark blue) corresponds to Si$^{3+}$ in the form of Si$_2$O$_3$ [54, 55]. A third species was deconvoluted in the Cu-silica-10.4 sample at 100.7 eV (dark green), close to the 101 eV binding energy of Si$^+$ [54–56]. Such down-shifting of the Si binding energy has been attributed to interaction of silica with Cu atoms [9, 57]. The up-shifted Cu$^{2+}$ peak and the down-shifted Si$^{2+}$ peak suggest an interaction where Cu is slightly positive and the Si is slightly negative.

Figure 4: High resolution XP spectra of Cu2p$_{3/2}$ (a) and Si2p (b) atomic orbitals. Cu-silica samples generated under same experimental conditions, with different pH solutions.

Figure 5 displays the FTIR spectra of the three samples along with a control silica-10.4 sample, generated by ablating a silicon wafer immersed in water adjusted to pH 10.4 with KOH. The peaks at 800 and 1090 cm$^{-1}$ in the control sample (gray) correspond to the symmetric and asymmetric stretching of amorphous silica. These two bands are prominent in the Cu-silica-3.0 and -5.4 samples (red and blue), but the 800 cm$^{-1}$ band is nearly absent Cu-silica-10.4 spectrum (magenta). Moreover, the 1090 cm$^{-1}$ band is significantly down-shifted to 968 cm$^{-1}$. This shift corresponds to a shift in bonding environment
from Si–O–Si to Si–O–Cu, due to the longer Cu–O bond length than Si–O [57]. This band is also close to the 1024 cm\(^{-1}\) feature in Cu-PS [6, 58–60]. The Cu-silica-10.4 sample also has a weak feature that could be attributed to Cu(OH)\(_2\) at 690 cm\(^{-1}\), Cu-PS at 670 cm\(^{-1}\), or both [6, 58–61]. The broadness of this band and the weak intensity make it difficult to distinguish between these copper structures. The peak around 1400 cm\(^{-1}\) that is present in the Cu-silica-3.0 sample likely arises from the symmetric stretching vibration of nitrate groups in Cu\(_2\)NO\(_3\)(OH) [62]. All samples have peaks around 1652 cm\(^{-1}\), which corresponds to the O–H bending mode of adsorbed water [11, 62].

Figure 5: FTIR spectra of silica-pH 10.4 (generated from ablating Si wafer in water at pH 10.4), the Cu-silica-3.0, Cu-silica-5.4, and Cu-silica-10.4 samples.

XRD patterns of the Cu-silica-10.4 (magenta) and Cu-silica-5.4 (blue) samples are displayed in Fig. 6 compared to a control sample in which a silicon wafer was ablated in water (black). All samples contain sharp, intense peaks located at
There are 28.4, 47.3, 56.1, 69.2, 76.4, and 88.1 \(2\theta\) corresponding to the (111), (222), (331), (440), (533), and (640) planes of cubic silicon (ICDD: 04-012-7888). There is a small, broad peak around 36 \(2\theta\) present only in the Cu-silica-10.4 sample that corresponds to either the (111) CuO plane (35.6 \(2\theta\)), the (111) plane of Cu\(_2\)O (36.5 \(2\theta\)), or a Cu-PS structure [6, 58–60]. The inset shows the Gaussian peak fit yielding a FWHM of 4.90 \(2\theta\) corresponding to a 1.78 nm diameter of the crystalline nanoparticle, according to the Scherrer equation [63]. The FWHM of the fcc-Si (111) peak at 28.4 \(2\theta\) was determined to be 0.25 \(2\theta\), yielding a silicon crystalline diameter of 33.6 nm. The XRD pattern shows that there are crystalline silicon particles present in these samples, consistent with the large spherical particles visible in the TEM images in Fig. 1a. The absence of silica in the XRD patterns supports the amorphous nature of the silica as evident in the HRTEM images, Si2p XPS spectra, and FTIR spectra.

Figure 6: XRD patterns of Cu-silica-10.4, Cu-silica-5.4, and silica generated from laser ablation of silicon wafer in water.
3.2. Catalytic Activity

The catalytic reduction of para-nitrophenol (PNP) by sodium borohydride was employed as a model reaction to compare the catalytic activity of the silica-Cu samples. Because all samples were irradiated under the same laser conditions and underwent the same post-synthesis processing procedure, we assume the amount of silica present in all samples is equivalent, and the rate constants reported reflect the catalytically active copper particles in the samples. Therefore, the same volume of re-dispersed pellet was added to all PNP reactions. Experimental details and calculations for determining the catalytic rate constants have been described in detail elsewhere [36, 38] and are provided in the Supplemental Information.

Briefly, the catalytic reduction of PNP to para-aminophenol (PAP) by sodium borohydride follows pseudo-first order reaction kinetics due to the excess of NaBH$_4$ added to the reaction

$$\text{PNP} + \text{NaBH}_4 \xrightarrow{Cu\text{-silica}} \text{PAP.} \quad (1)$$

The para-phenolate ion absorbs strongly at 400 nm, allowing for the reaction rate to be determined by monitoring its absorbance upon the addition of the catalyst. The apparent rate constants, $k_{\text{app}} \ (s^{-1})$ versus wt.% Cu from XPS analysis are displayed in Fig. 7, with the different pH conditions labeled. There is a linear relationship between the rate constant and the surface Cu content, reflecting the high catalytic activity of the Cu-silica-10.4 sample which contains the highest amount of surface Cu. While nearly no Cu was detected in the Cu-silica-3.0 sample, it still possess catalytic activity, suggesting that the there was Cu present in the sample, but in very small quantities.
4. Discussion

Wet chemical approaches to fabricating oxide supported metal nanoparticles emphasize the importance of choosing the support, metal precursor, and solution pH for maximizing the metal loading [64]. Determining the point of zero charge (PZC) of the support material aids in identifying the pH conditions for optimal interaction between the metal complex and the oxide support [64, 65]. The PZC of a material is the pH at which the hydroxyl groups that populate the surface of an oxide have a neutral charge. When the pH is below the PZC of the support, the hydroxyl groups are protonated, and when the pH is above the PZC, the hydroxyl groups are deprotonated [13, 15, 64]. Silica has a PZC of pH 4, so when the solution pH is above this value, cationic metal complexes in solution can adsorb onto the negatively charged surface of the silica [15].

The copper loadings reported in Table 2 demonstrate the need for basic pH to achieve high copper loading under our synthesis conditions; even in the weakly acidic solution at pH 5.4, little copper was found in the product. In contrast, the Cu-silica-10.4 sample had a high copper loading of 31.5 wt%; much
higher than many previous reports using wet chemical techniques that typically achieve around 10 wt.% [15, 65–69]. Previous investigations of pH-dependent metal loading on silica that achieved copper loadings above 30 wt.% have formed Cu-PS structures [10, 58, 70, 71], consistent with our results. However, the wet-chemical synthesis methods used are considerably more time- and material-consuming than our RLAL method. For instance, the method of Toupance et al., in which a copper nitrate solution adjusted to pH 9 using ammonia mixed with nonporous silica was stirred at room temperature for one week, required 100 times the amount of copper relative to our conditions to yield 36.6 wt.% Cu with 4.5 nm Cu NPs [58].

In contrast to pre-synthesized fumed silica or nonporous silica spheres used in wet chemical methods, our silica is produced in situ from laser ablation. As the silicon atoms and clusters are ejected into solution, they may interact with other nearby species including hydrated electrons and hydroxyl radicals, resulting in oxidation to silica. Under basic conditions, nearby OH\(^-\) ions may interact with the oxidized silica clusters, deprotonating their surfaces [72]. The negatively charged silica clusters attract nearby copper in the form of the bridged copper hydroxide dimer, \(\text{[Cu}_2\text{(OH)}_2]^2+\), which is formed in the pH range 6.5–10.5 [15, 73]. The abundance of deprotonated silica clusters generated from laser ablation provide numerous sites for these copper complexes to interact with, driving the high copper loading under basic conditions.

Figure 8 displays a graphical representation of the formation mechanisms of the copper-silica materials under the different pH conditions. We note that the solution pH decreased from 10.4 to 8.5 and 5.4 to 4.2 during synthesis of the Cu-silica-10.4 and -5.4 samples, respectively. The two samples generated at final solution pH less than pH 4 are shown above the ‘silica PZC 4.0’ line [13, 15] in Fig. 8. Under these conditions, silica clusters ablated off of the Si wafer into solution become protonated and repel the surrounding Cu\(^{2+}\) ions, leading to low amounts of Cu incorporated into the product. While it is possible that a small amount of Cu in the product dissolves in the acidic solution following laser synthesis (see details in the Supporting Information), this process is unlikely to
be the primary cause of low Cu incorporation because little Cu is incorporated even at an initial pH of 5.4. For the particles in which Cu is incorporated into the particles, segregation of the Cu-silica phases result in large Cu-core/silica-shell particles with varying sizes and shell thicknesses. The formation of the silica shell rather than silica core may be due to the higher surface energy of silicon than copper in the liquid form. Synthesis of Cu-core/silica-shell particles by evaporating elemental Cu and Si using a high powered electron beam resulted in phase segregation with the silicon shell forming around liquid Cu, due to the higher surface energy of liquid silicon relative to liquid Cu [74, 75]. In contrast, the proposed formation mechanism of the Cu-silica-10.4 sample is displayed below the line labeled ‘silica PZC 4.0’, where Cu-O-Si bonds form due to the strong interaction between the deprotonated silica clusters and the cationic copper hydroxide dimers. The morphology contains sheet- and needle-like structures comprised of amorphous silica, copper phyllosilicate, or both, decorated with sub-2 nm Cu clusters. The small size of the Cu particles likely results from the strong interaction between the Cu nuclei and the silica clusters, halting further Cu NP growth. The presence of sub-2 nm clusters dispersed throughout the silica is similar to our recent report of fs-RLAL synthesis of sub-3 nm Au NPs dispersed throughout a silica matrix under basic conditions [36]. Our observation of distinct copper-silica material structures using fs-RLAL at different solution pH is consistent with previous RLAL studies showing a dependence of Pt-Co NP properties on solution pH [29, 30] and suggests that solution pH provides a generally applicable method to control nanomaterial properties with RLAL.

5. Conclusion

We have synthesized copper-silica nanocomposites using a fs-RLAL approach, with distinct copper-silica morphologies forming from different precursor solution pH conditions. The highest copper loading on silica of 31.5 wt.% achieved with a precursor solution pH of 10.4 generated 1.52±0.75 nm Cu NPs well dis-
persed throughout an amorphous matrix. TEM, XPS, XRD, and FTIR analysis are consistent with the coexistence of copper phyllosilicate and amorphous silica in the matrix. Lower solution pH of 5.4 and 3.0 resulted in Cu-core/silica-shell morphologies with Cu NP sizes ranging from 30–80 nm in diameter, and only 1.4–1.5 wt.% loading of Cu. The catalytic activity of the synthesized materials was proportional to the copper loading, with very low catalytic activity toward the reduction of para-nitrophenol from the samples synthesized at pH 3.0 and 5.4, and much higher catalytic activity from the sample synthesized at pH 10.4. The pH dependent compositions and morphologies of our copper-silica nanocomposites are attributed to the interaction of positively charged Cu precursor species and ablated silica species. At low pH, protonation of silica clusters results in copper and silica phase segregation, forming core-shell structures. At high pH, the copper hydroxide dimer ion strongly interacts with deprotonated silica clusters, resulting in sub-2 nm Cu clusters supported on a copper phyllosilicate/amorphous silica matrix. The results in this study demonstrate the importance of understanding the effect of solution pH on the electronic charge of ablated target material to allow for better control over the product morphology. This approach to synthesizing Cu-silica composite nanomaterials provides
valuable insight into designing RLAL reaction conditions for synthesizing additional metal-oxide nanocomposites with high metal loadings that may be used for catalytic applications.

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Supplemental Material

Details of PNP catalytic reactions; Details of HRTEM lattice fringe analysis; Details of XPS composition analysis; additional TEM images; additional XPS spectra of Si2p.

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